

Characterization of devices fabricated from electrostatically transferred graphene: comparison with epitaxial based devices

Stephen W. Howell

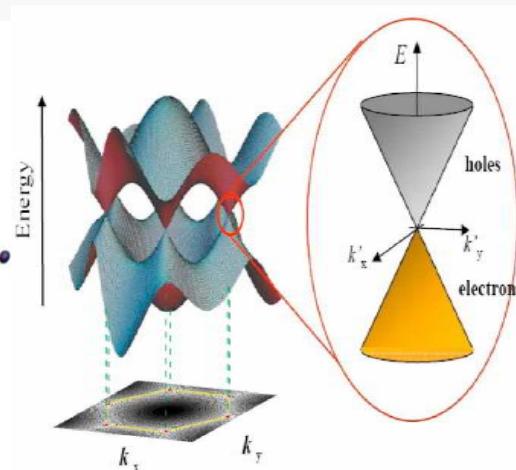
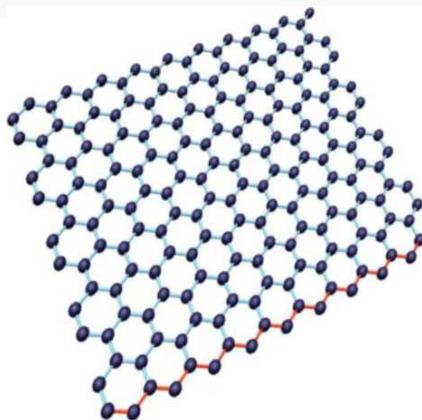
L.B. Biedermann, T. Ohta, W. Pan, A.J. Ross, T.E. Beechem and D.C. Trotter

Sandia National Laboratories
October 20, 2010

Sandia is a multiprogram laboratory operated by Sandia Corporation, a Lockheed Martin Company, for the United States Department of Energy's National Nuclear Security Administration under contract DE-AC04-94AL85000.

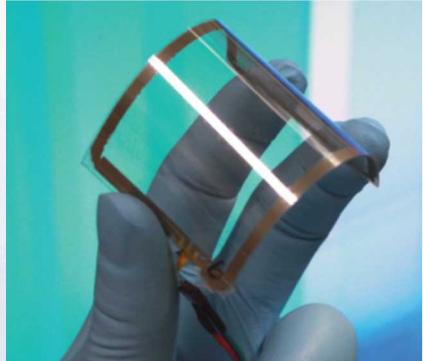


Why graphene?



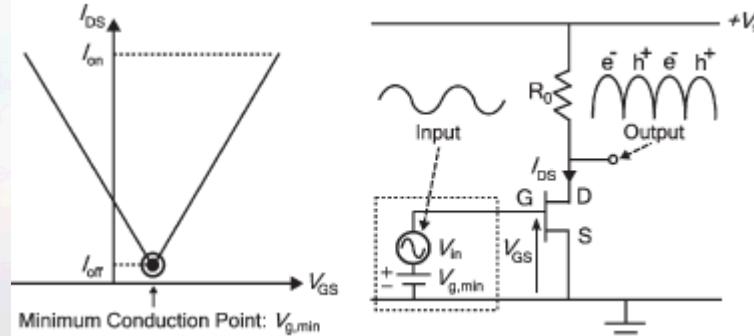
Mobility, μ , up to 250,000 cm²/Vs
(suspended exfoliated graphene)
Ambipolar, zero-bandgap
Current densities up to 5×10^8 A/cm²
Elastic modulus ~ 1 TPa

Transparent electrodes



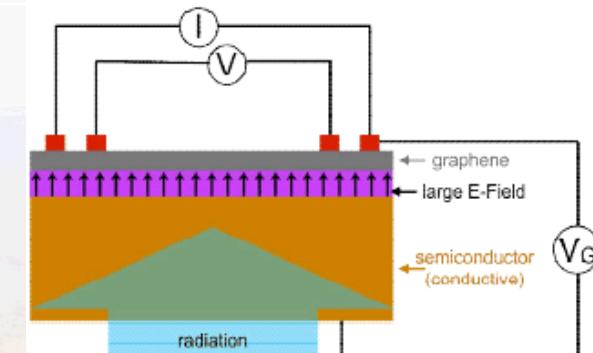
S. Bae *et al.*, *Nature Nano.*, **5**, 574-578 (2010)

Frequency multiplier
(ambipolar transport)



H. Wang *et al.*, *IEEE Elec. Dev. Lett.*, **30**, 547-549 (2009).

Read-out for radiation detection



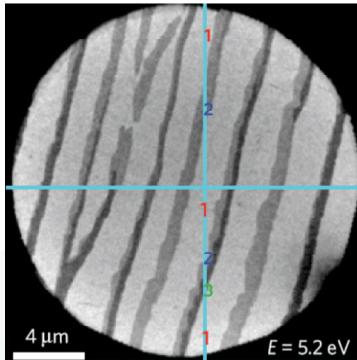
M. Foxe *et al.*, *IEEE Trans. Nuclear Sci.*, submitted (2010).



Sandia's graphene effort

- Sandia is in the 3rd year of an internally funded project that is focused on developing the scientific biases required for synthesis of high quality graphene

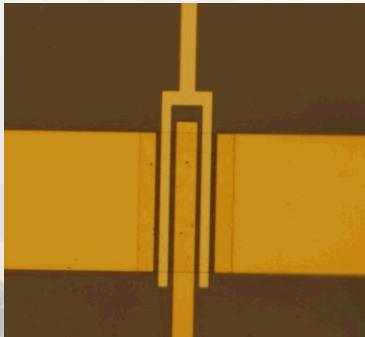
Thermal Decomposition
of SiC (Ohta)



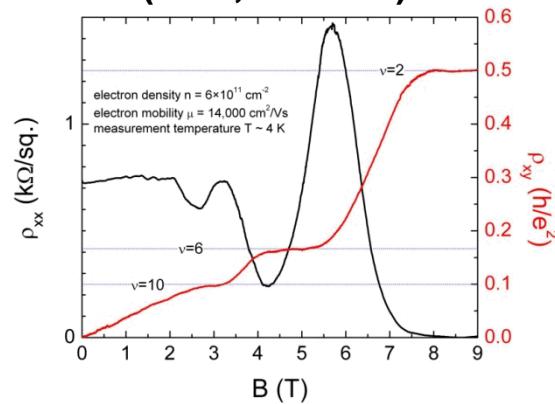
CVD Dep on Metals
(McCarty)



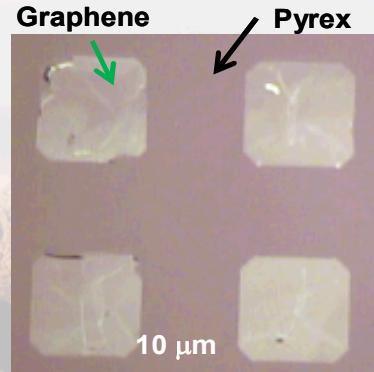
GFET Development
(Howell)



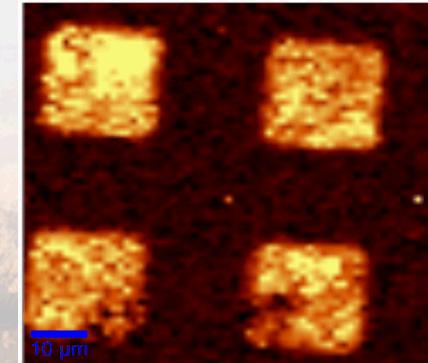
Transport Measurements
(Pan, Howell)



Transfer
(Biedermann, Howell)



Raman Mapping
(Beechem, Ohta)





Motivation for transferring epitaxial graphene (EG) from SiC

- Why use EG on SiC?

- EG grown on SiC has the potential for high carrier mobility
- Current synthesis approaches allow for tight control of graphene thickness (monolayer and bilayer coverage)

- Development of a scalable transfer technology could:

- Enable EG integration with current CMOS processes
- Enable new types of MEMS device structures



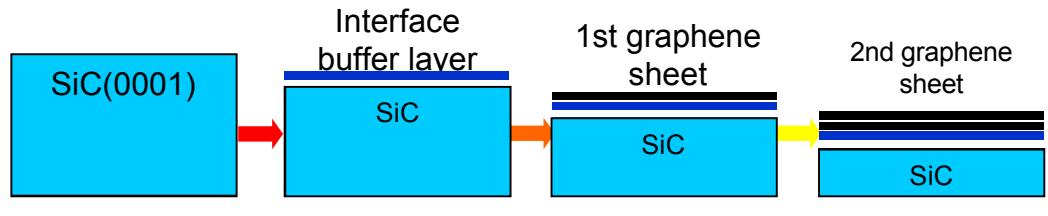
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Synthesis approach for epitaxial graphene (EG) on SiC

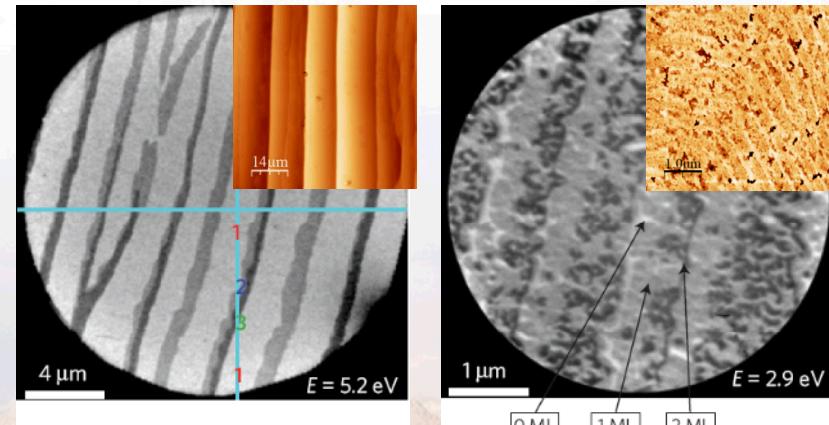
■ Graphitization of SiC:

- Sublimation of Si at high temperature (>1200 °C) leaves graphene layer at SiC surface



• Argon-assisted graphene formation yields large (~ 100 μm^2) graphene domains

- Samples prepared using Ar atmosphere at atmospheric pressure and high temp
- Using this method we have exquisite control of :
 - Domain size
 - Percentage coverage of mono/bilayers



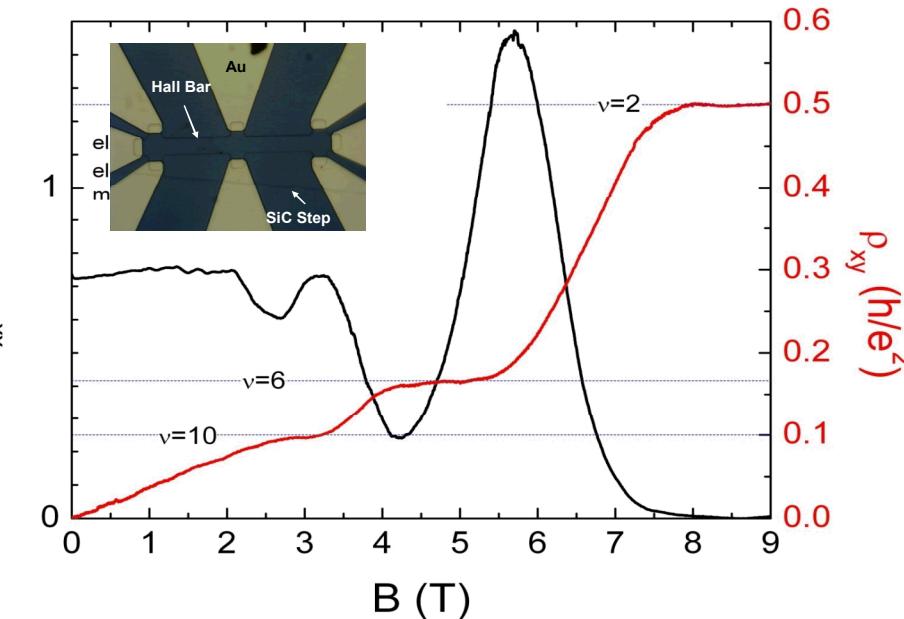
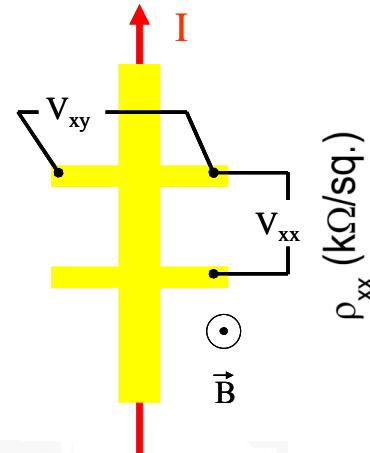
K. V. Emtsev et al., Nature Mater. 8, 203 (2009).
C. Virojanadara et al., Phys. Rev. B 78, 245403 (2008)



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Electronic characterization of EG grown on SiC

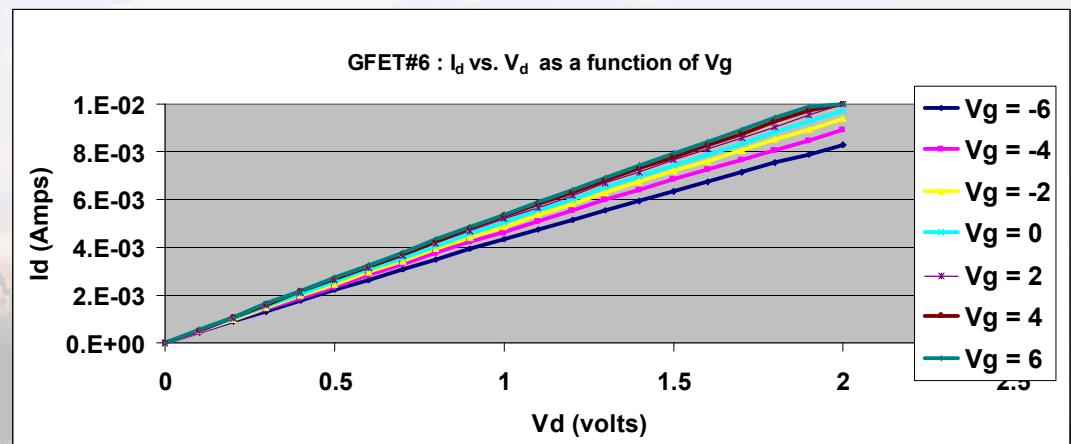
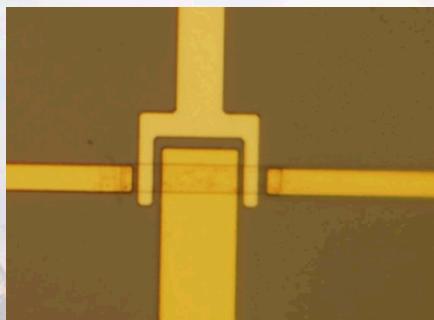
Low Temp Transport Measurements



- Epi-graphene electron mobility: 14,000 cm²/Vs
- Electron density: 6 x 10¹¹ cm⁻²
- Graphene sheet resistance: ~1600 Ω/sq (average from 12 devices)
- Observed IOHE on 3 devices on the same chip

Pan *et al.*, accepted by APL

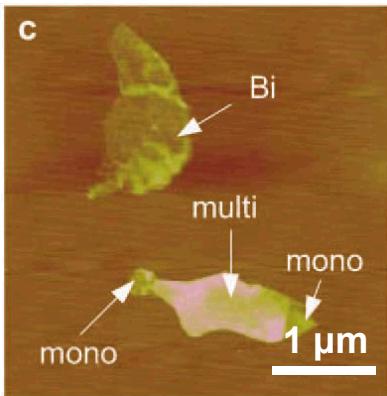
GFET Development



Methods to transfer EG to SiO_2

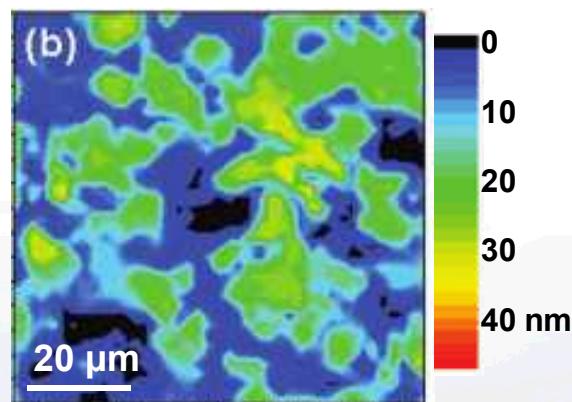


Thermal release tape
+ 5 N/mm² pressure



Si-face EG
Small flakes

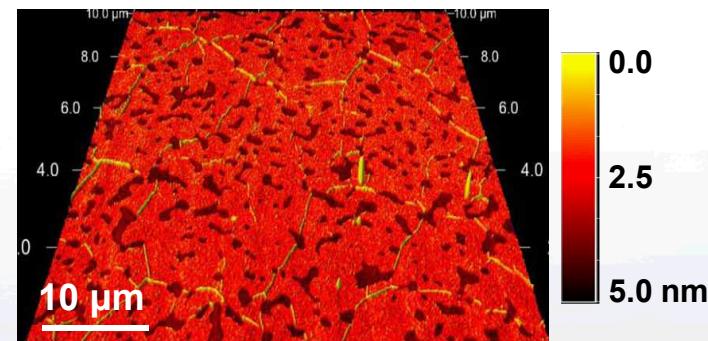
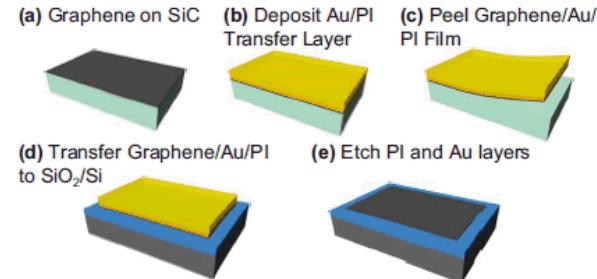
D. Lee *et al.*, *Nano Lett.* **8**, 4320-5 (2008).



C-face EG
Very thick graphene
 $\mu \sim 1350 \text{ cm}^2/\text{Vs}$

J. Caldwell *et al.*, *ACS Nano* **4**, 118-14 (2010).

Gold/polyimide film handle

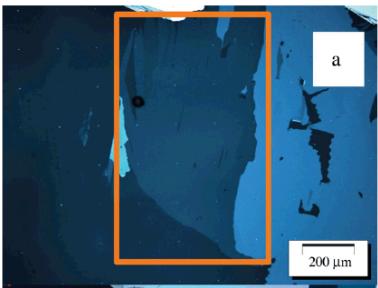


Si-face EG
Damaged graphene
 $\mu \sim 100 \text{ cm}^2/\text{Vs}$

S. Unarunoai *et al.*, *APL* **95**, 202101 (2009).



Voltage-driven exfoliation of graphite

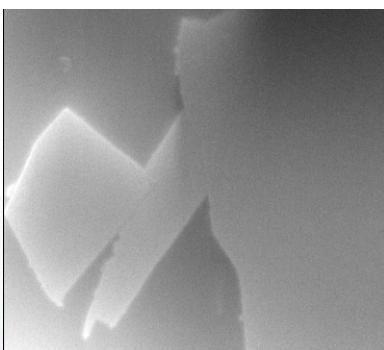


Graphite to Pyrex

1.2 – 1.7 kV

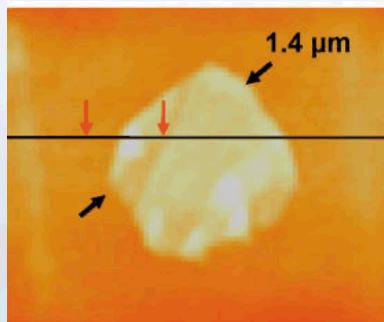
$\mu \sim 10^4 \text{ cm}^2/\text{Vs}$

A. Shukla *et al.*, *Solid State Comm.* **149**, 718-21 (2009).



HOPG to SiO_2
3-30 kV

A. Sidorov *et al.*,
Nanotechnology **18**,
135301 (2007).

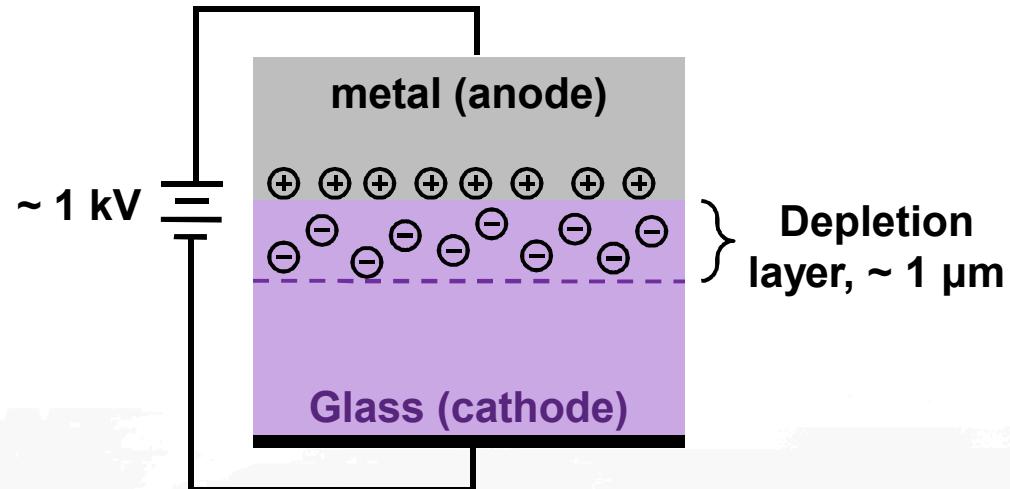


Pre-patterned
HOPG to SiO_2
8.5 V

$\mu \sim 1050 \text{ cm}^2/\text{Vs}$

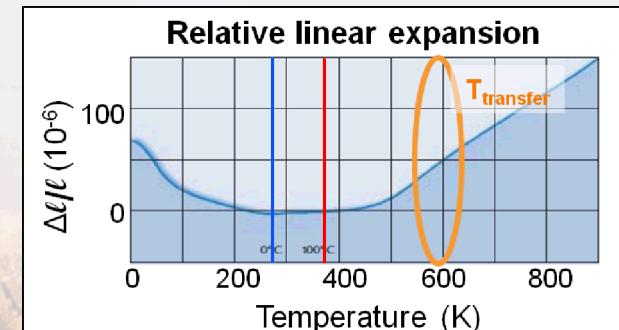
X. Liang *et al.*, *Nano Lett.* **9**, 467-72 (2009).

Shukla's method is derived from anodic bonding.



Common glasses are Pyrex, borosilicate glass, and Zerodur.

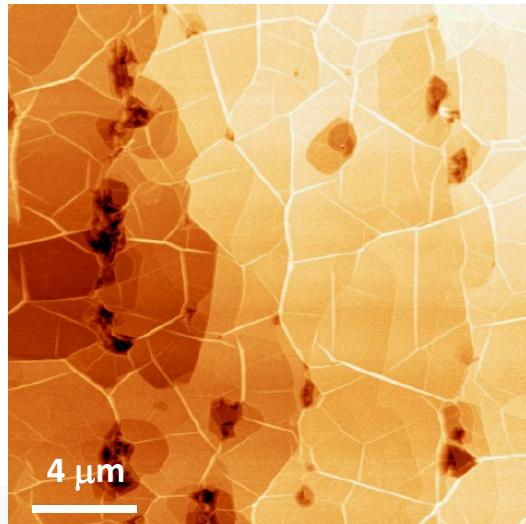
Zerodur is a Li_2O_3 -
 Al_2O_3 - SiO_2 glass ceramic



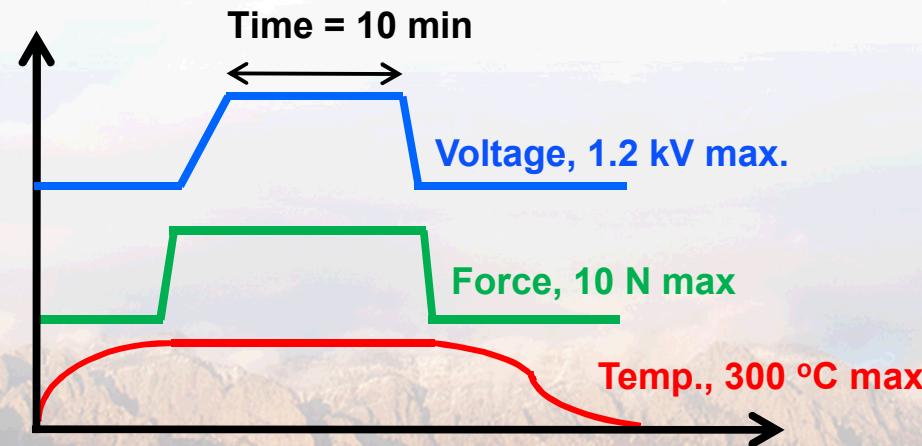
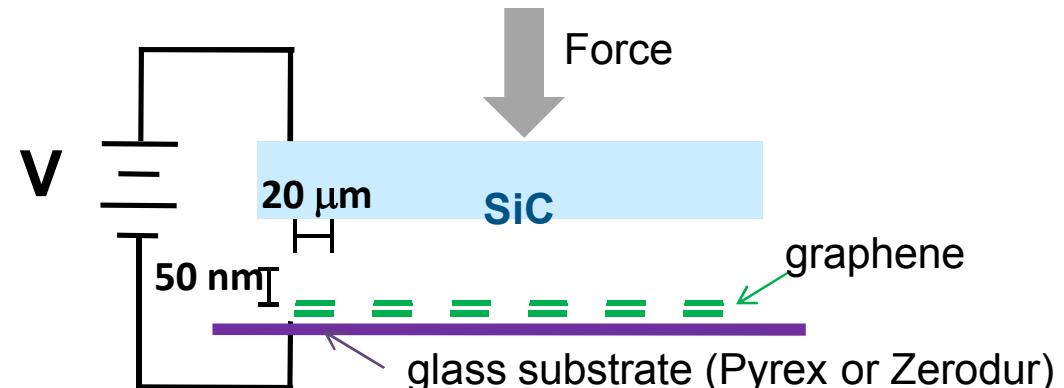
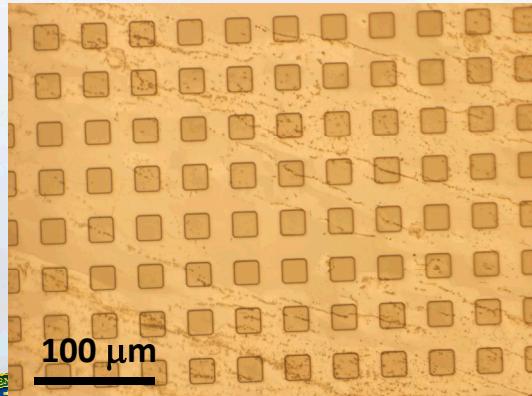
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Graphene transfer procedure

As-grown C-face graphene

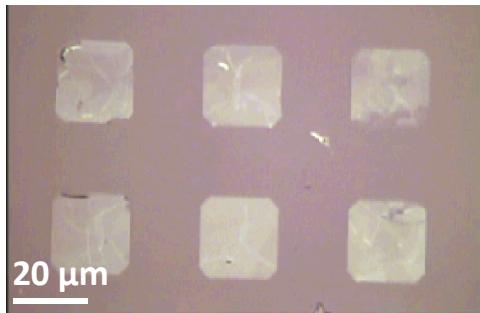


Patterned graphene



How to judge graphene transfer

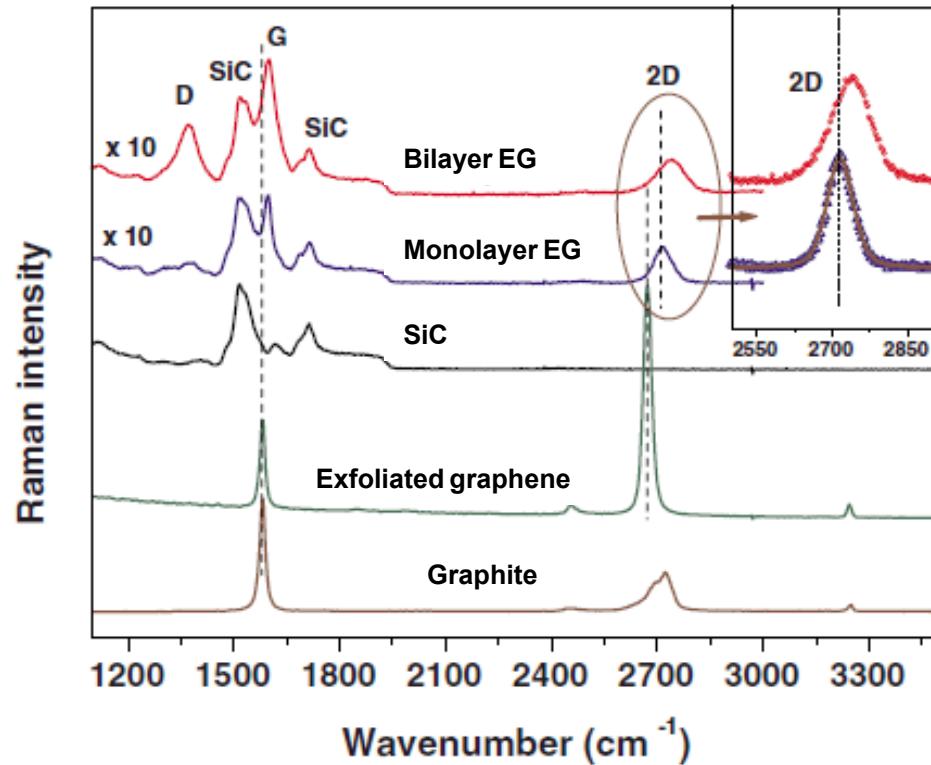
Optical microscopy



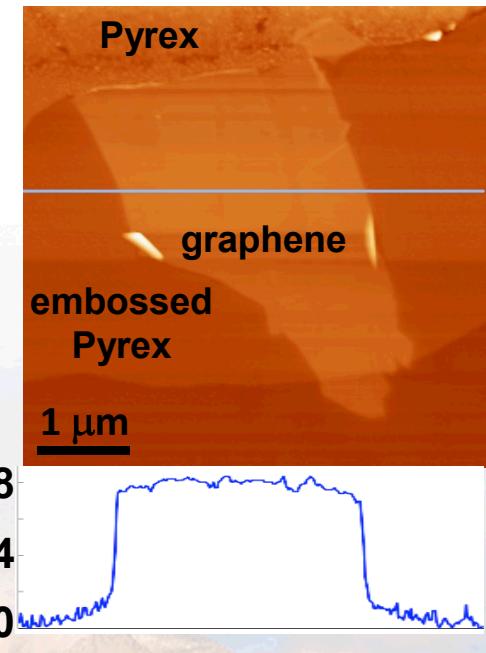
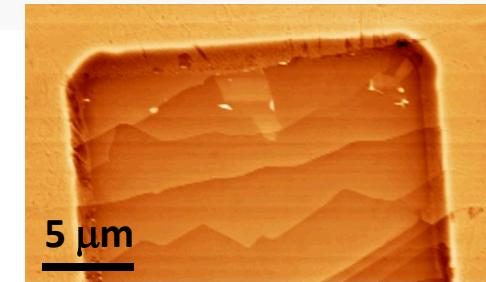
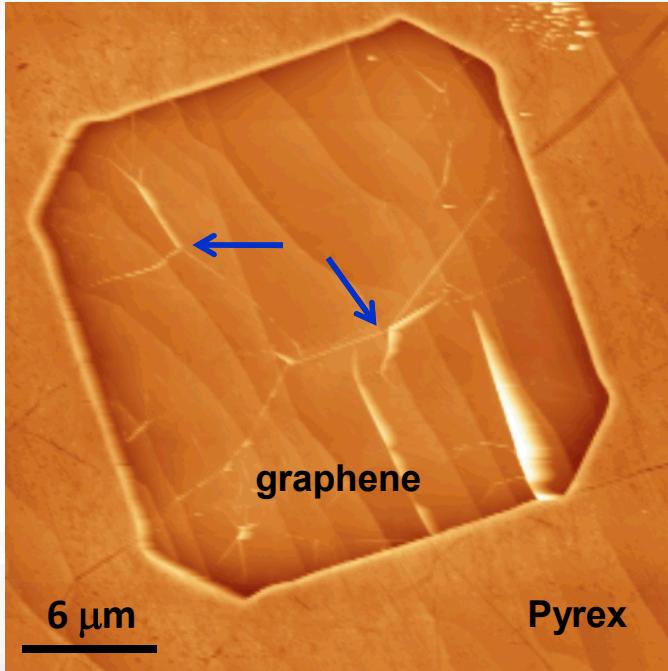
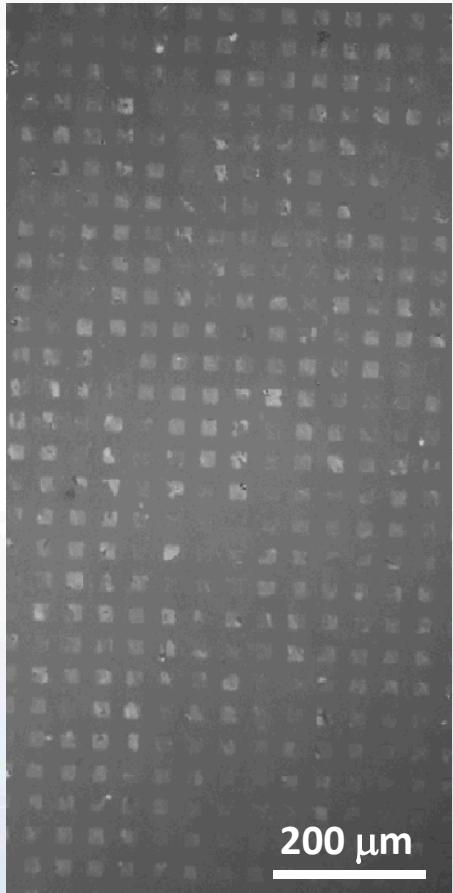
Atomic force microscopy



Raman spectroscopy



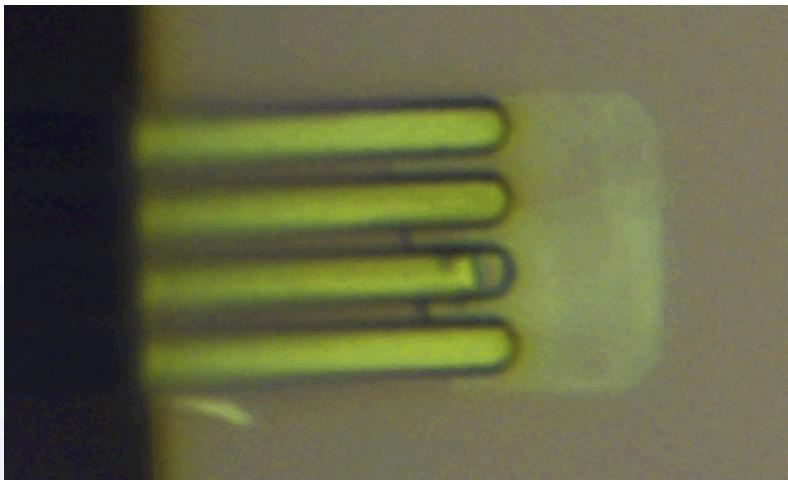
C-face graphene squares transferred to Pyrex





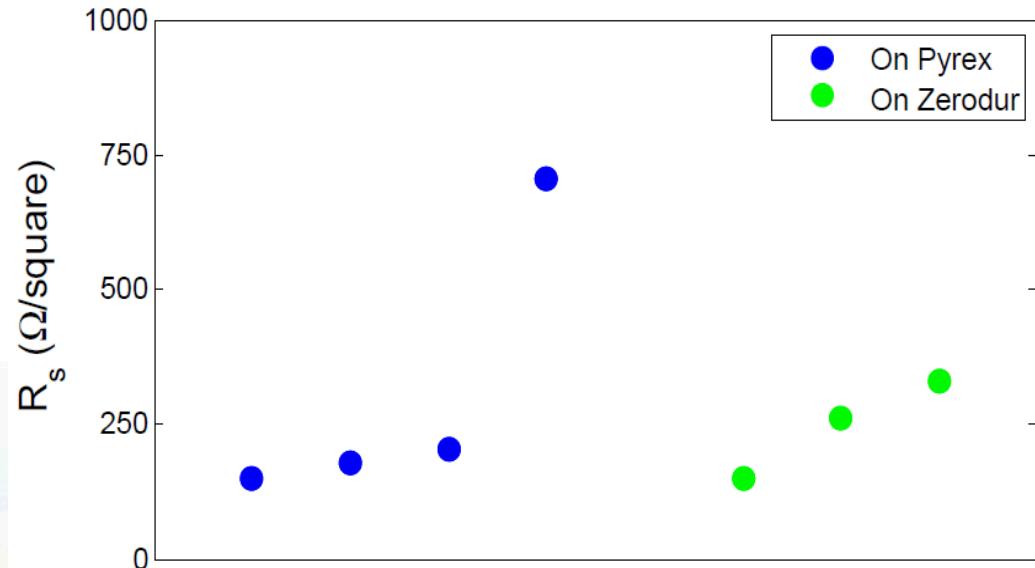
Electronic characterization of transferred graphene from SiC (C-face)

Graphene transferred from the C-face has R_s as low as $150 \Omega/\square$.



Micro four probe on $10 \times 10 \mu\text{m}^2$ square of transferred graphene

$$R_s = \frac{\pi}{\ln 2} \frac{V}{I}$$



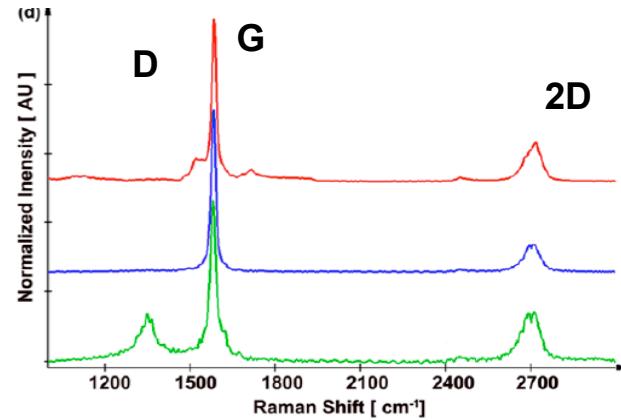
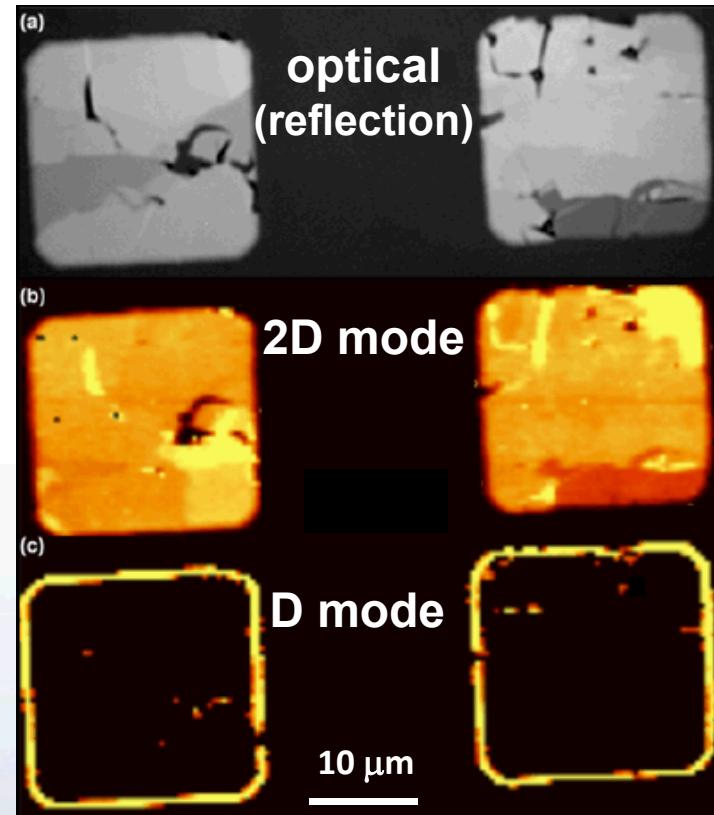
L. Biedermann, T. Beechem, A. Ross, T. Ohta, and S. Howell,
submitted to *New J. of Physics*.



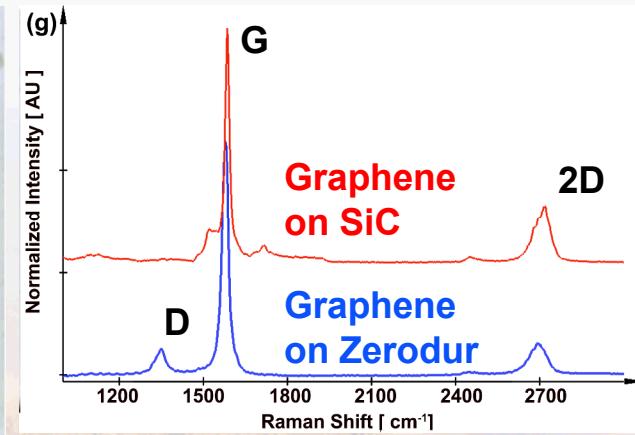
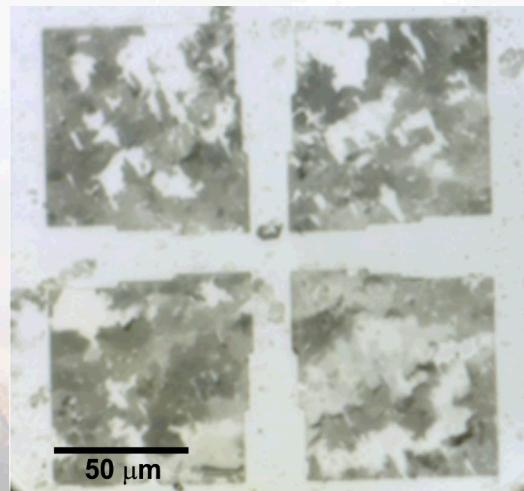


Raman analysis confirms graphene transfer

Graphene on Pyrex

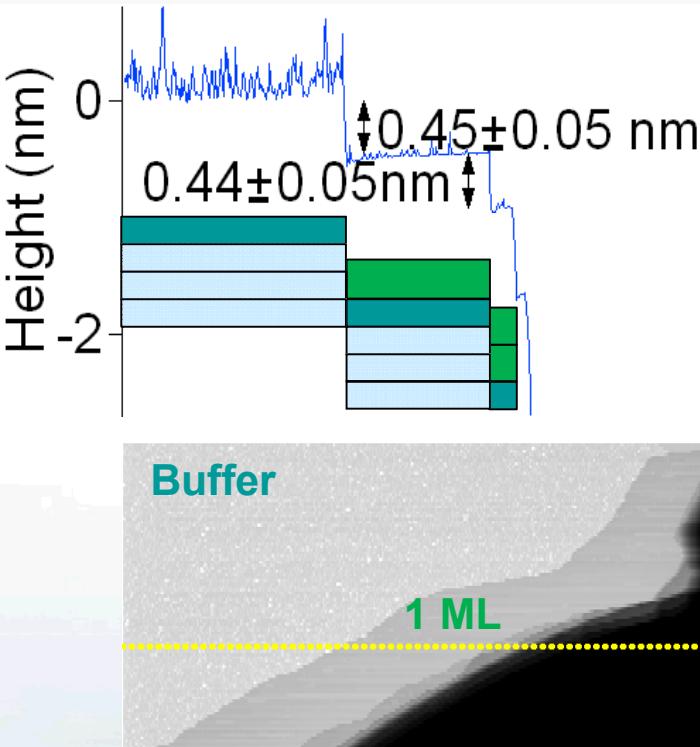


Graphene on Zerodur





About-face: Si-face epitaxial graphene

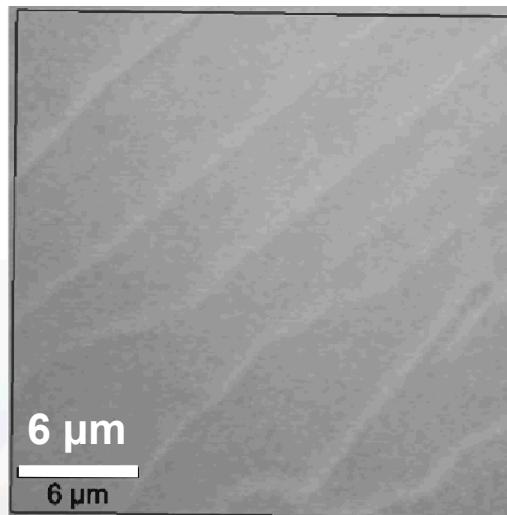


T. Ohta *et al. Phys Rev B* **81**, 121411(R) (2010).

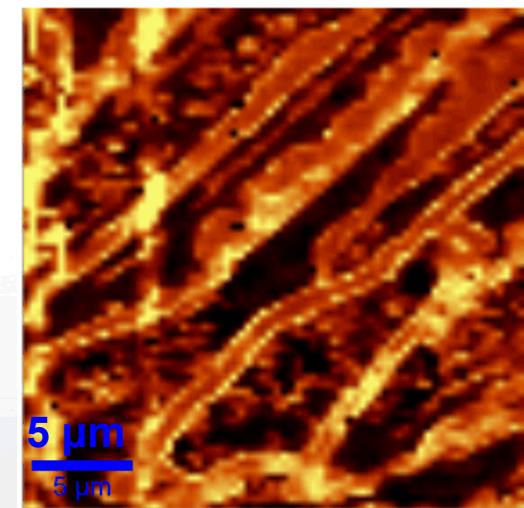
Sample 090728 #27

60 % 1 ML, 30 % 2 ML, 10 % \geq 3 ML

Optical



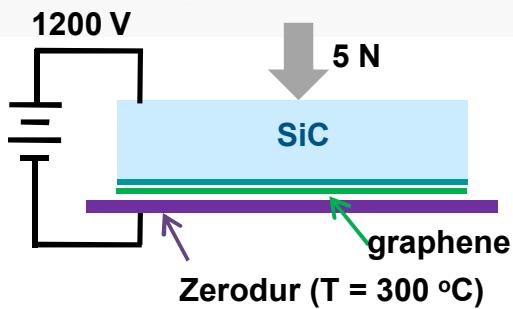
2D FWHM



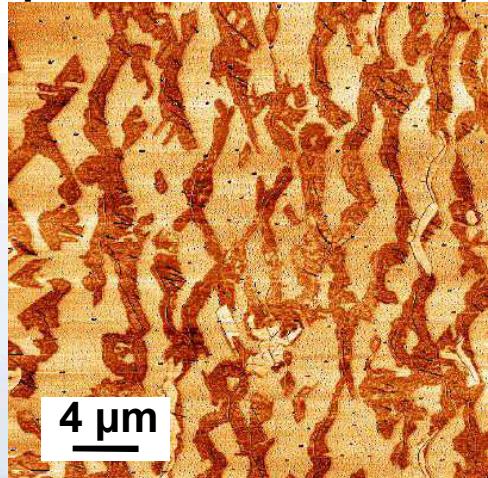
Mobility at 4 K: $\mu = 14000 \text{ cm}^2/\text{Vs}$
Wei Pan, Sandia



Chip-scale transfer of Si-face graphene to Zerodur

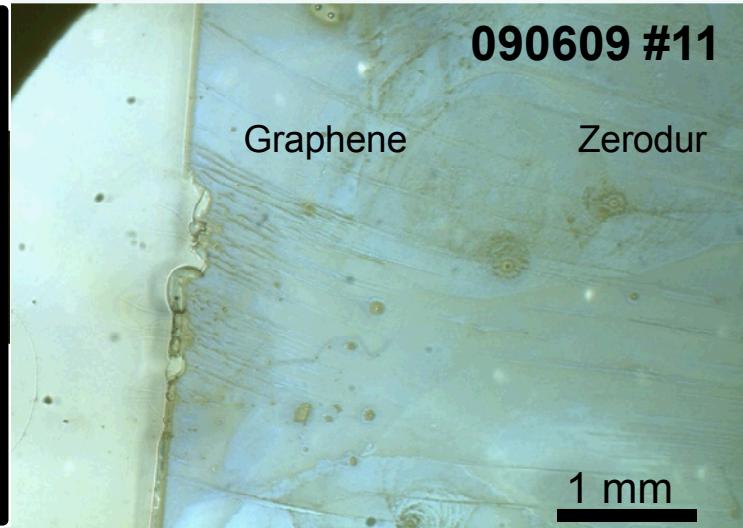
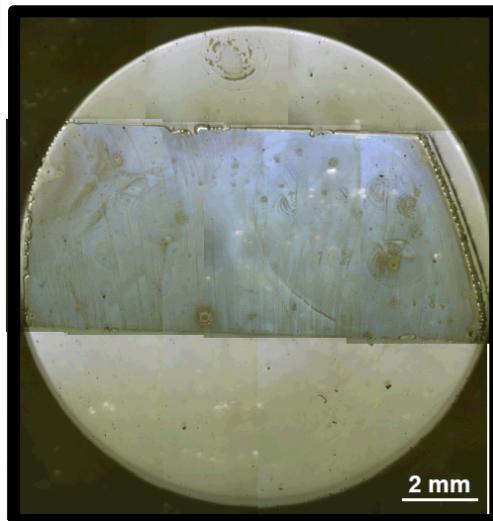


Graphene on SiC,
prior to transfer (AFM)

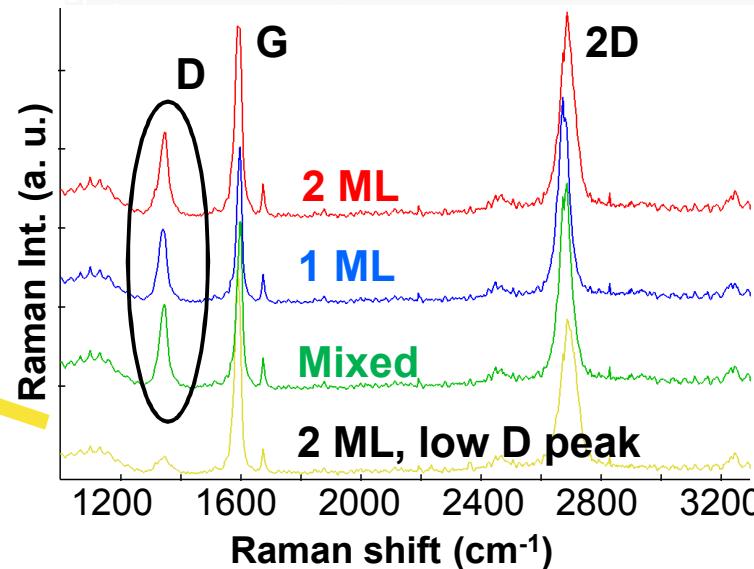
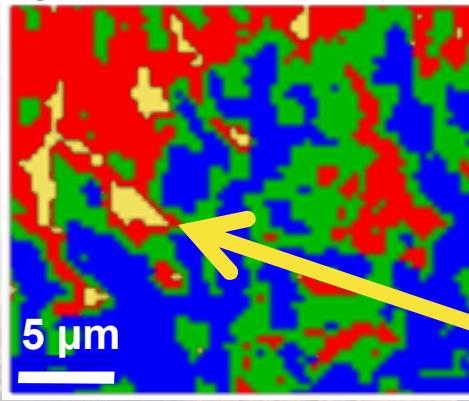


Bright phase = 1 ML

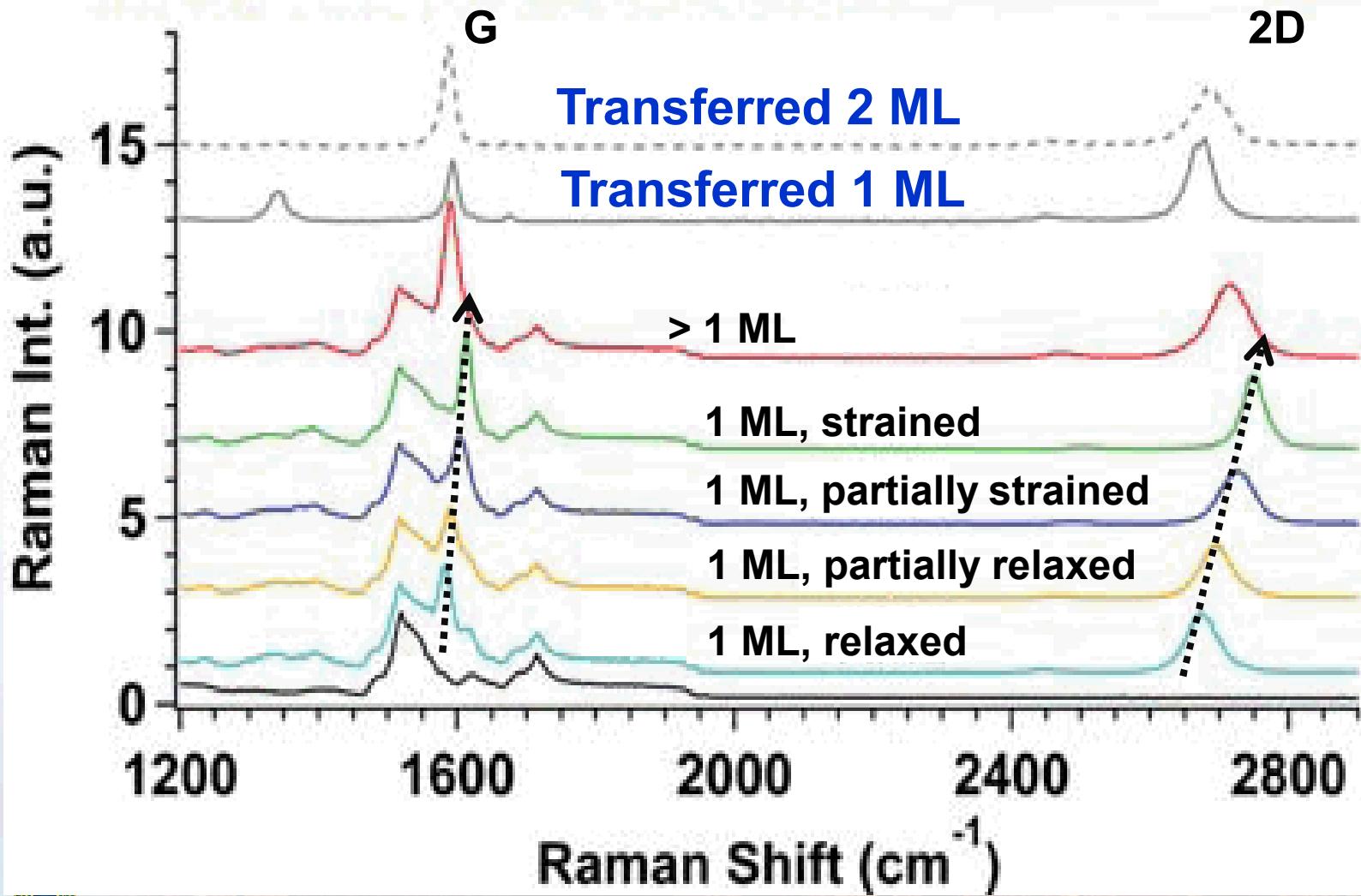
Dark phase = 2 ML



Cluster analysis of
graphene on Zerodur



Transfer relaxes strain inherent in epitaxial graphene



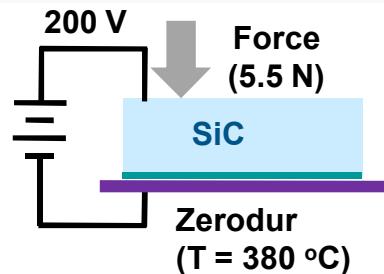
D. Schmidt *et al.*, submitted to *Nano Letters* (2010).



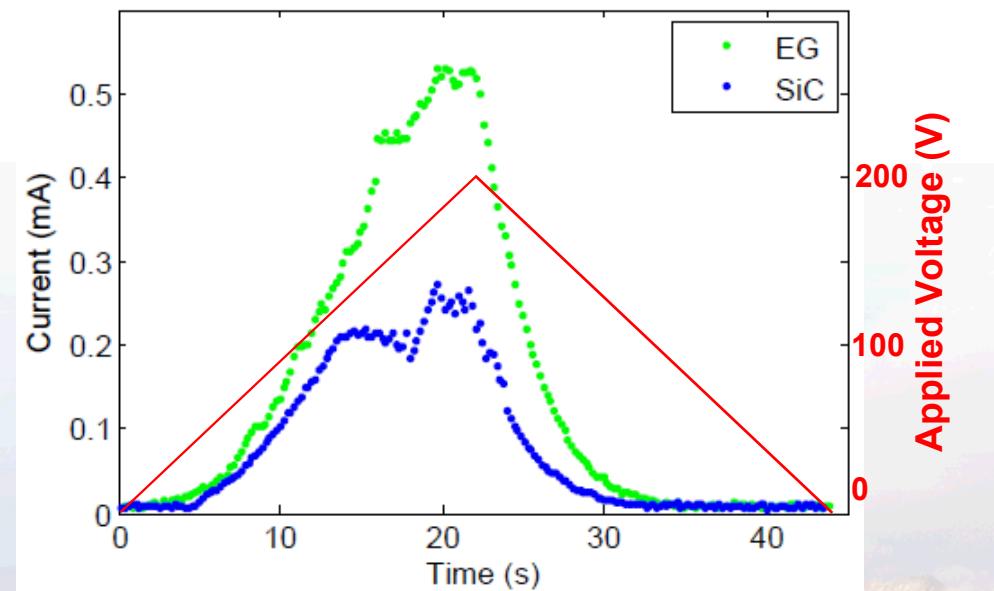
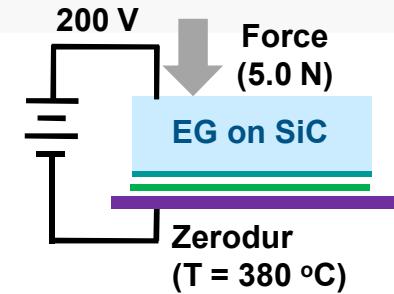
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Electrochemical analysis suggests graphene is bonding to the Zerodur

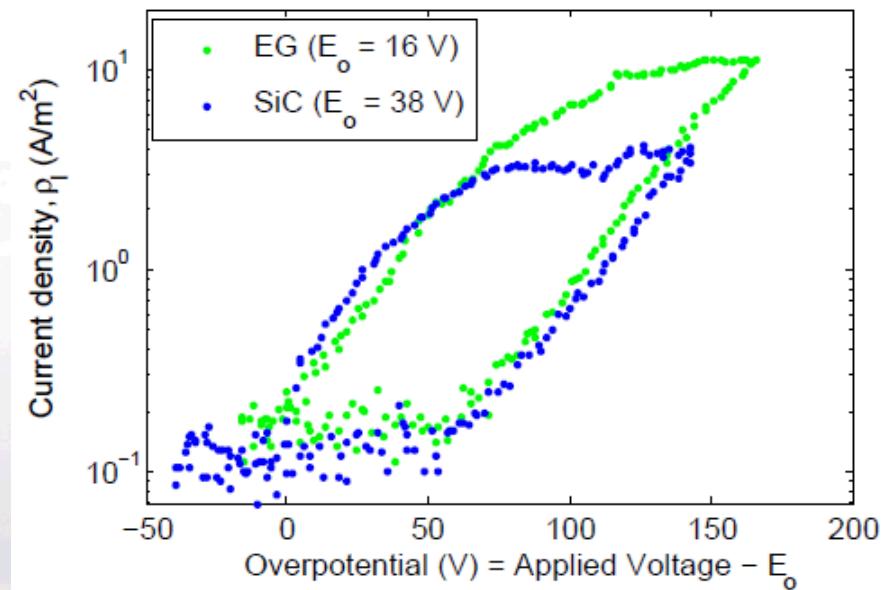
Anodic bonding of SiC to Zerodur



Transfer of EG to Zerodur



•Zerodur cannot be removed without breaking SiC



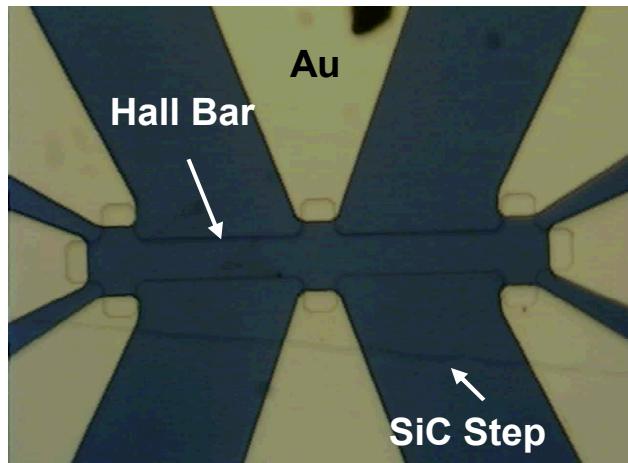
•Zerodur releases from graphene/Zerodur with little force



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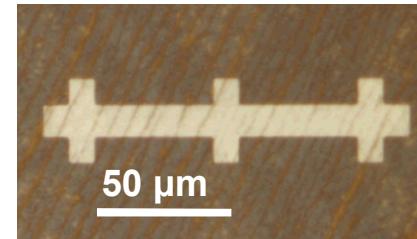
Comparison of transferred Si-face graphene to EG

EG Hall bar on SiC(0001)



- Epi-graphene electron mobility: 14,000 cm²/Vs
- Electron density: 6×10^{11} cm⁻²
- Graphene sheet resistance: $\sim 1600 \Omega/\text{sq}$ (average from 12 devices)

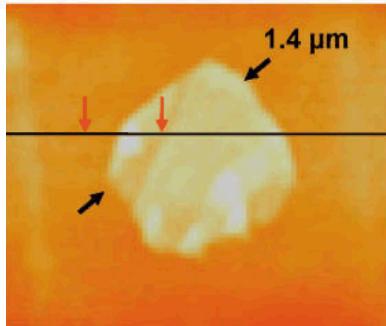
Hall bars structures, Si-face graphene on Zerodur



- Poor large scale transfer (most Hall bars are open circuit across their length)
- Measurements across small distances (< 10 μm) do show some electrical activity (~ 5 kΩ - 5 MΩ)
- The transferred material appears to be isolate ribbons of graphene
 - Breaks could be caused by SiC steps



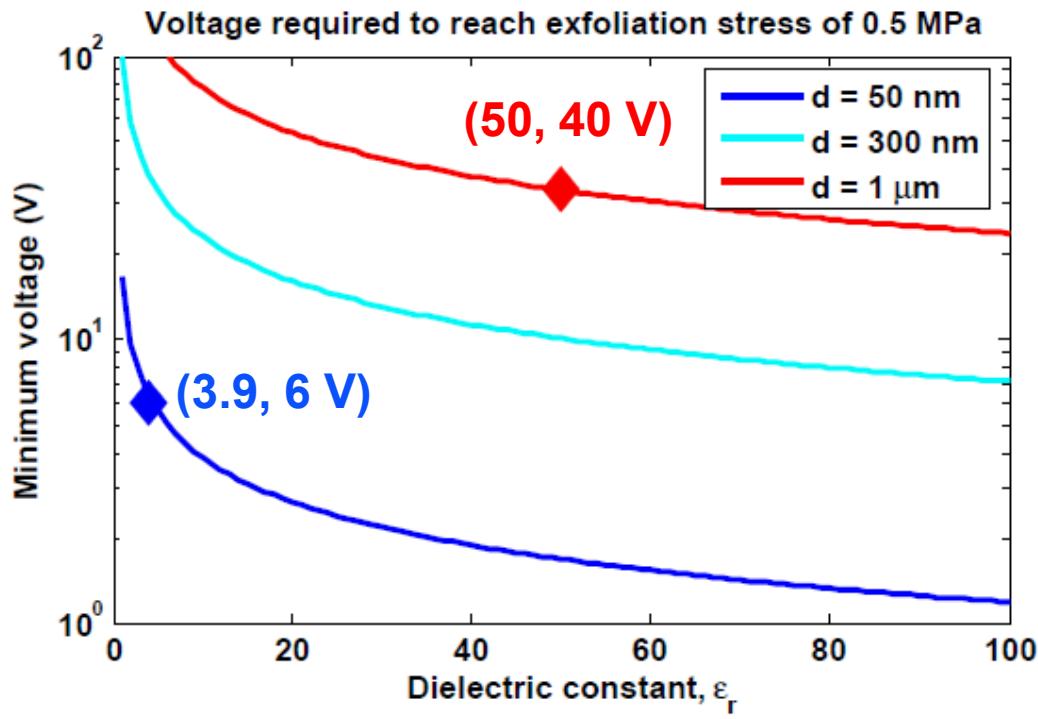
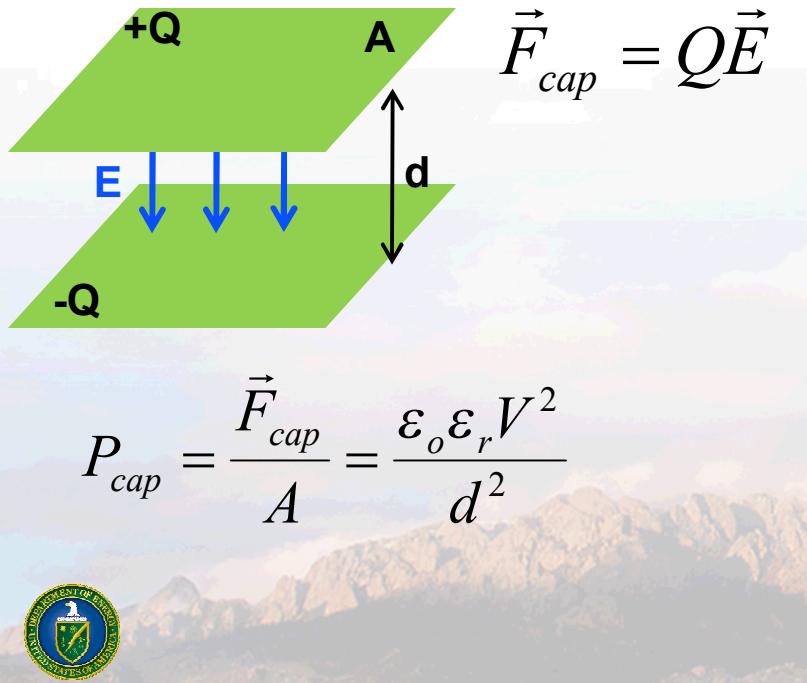
Ongoing work: Electrostatic rather than electrochemical transfer



Pre-patterned
HOPG to SiO_2
8.5 V
 $\mu \sim 1050 \text{ cm}^2/\text{Vs}$

X. Liang *et al.*, *Nano Lett.* **9**, 467-72 (2009).

The exfoliation strength of graphite is $\sim 0.4 \text{ MPa}$.





Conclusions

- Demonstrated transfer of graphene to Pyrex and Zerodur from the C-face of SiC
- Graphene transferred from C-face was characterized with Raman and mico four probe
 - The average resistance was found to be **XXX** Ω/Sq
- Attempted transfer of graphene monolayer from Si-face of SiC
- Characterized with Raman Spectroscopy
 - Detected presence of defects
 - Showed relaxation in strain
- Electrical charterization determined that the transferred films were not continuous over large length scales (transfer of ribbons)
- Current monitor during transfer indicated possible chemical bonding to Zerodur



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Graphene collaborators

Laura Biedermann, Transfer

Thomas Beechem, Raman spectroscopy

Taisuke Ohta, epitaxial graphene growth

Anthony (TJ) Ross, lithography and etching

Jeff Stevens, etching

Graham Yelton, electrochemistry advice



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Backup Slides



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Explored transfer parameter space; transfer still damages graphene

	Range	090609 #11	081209 #30	090609 #33	090728 #06	090401 #03	0907278 #18
Voltage (kV)	0.2 – 1.2	1200	530	525	525	550	550
Force (N)	2 – 10	5.0	4.0	4.2	3.9	8.9	7.7
Time (min)	1 – 10	10	4	3.5	1	4	5
Temp (°C)	300 – 390	300	370	370	370	390	370
% 1 ML	45 – 85	50	45	80	80	85	75
I(D) / I(G)		1.0	1.3	1.0	0.7	1.4	1.2

Metric for graphene quality:

$$\frac{I(D)}{I(G)} = \frac{\text{D-peak intensity}}{\text{G-peak intensity}}$$

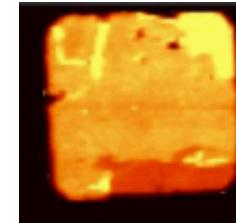
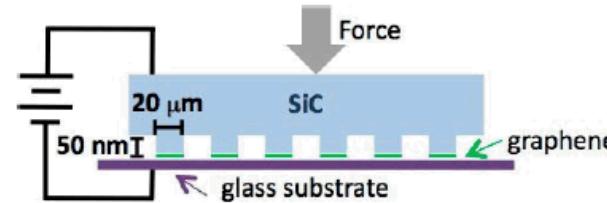


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Graphene transfer

- Scanning tunneling microscopy and atomic force microscopy
- Graphene transfer to insulating substrates
- Laser Doppler Vibrometry
- Casimir force measurements



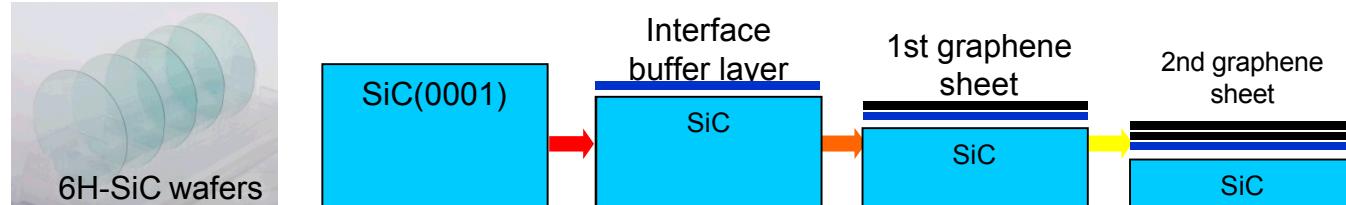
- **LDRD 11-0876: Enabling Graphene Nanoelectronics**
 - PI: Stephen W. Howell, PM: Carlos Gutierrez
 - Core team: Thomas Beechem, Tom Friedmann, Tim Lambert, Kevin Leung, Kevin McCarty, Taisuke Ohta, Wei Pan, Anthony Ross, Jeff Stevens, Cody Washburn, and David Wheeler
 - Publications submitted:
 - L. Biedermann, T. Beechem, A. Ross, T. Ohta, and S. Howell, "Electrostatic transfer of patterned epitaxial graphene from SiC(000-1) to glass," submitted to *New J. of Physics*.
 - D. Schmidt, T. Ohta, L. Biedermann, S. Howell, and G. Kellogg, "Inhomogeneous strain fields in epitaxial graphene," submitted to *PNAS*.



Understanding Graphene Growth on SiC

■ Graphitization of SiC:

- Sublimation of Si at high temperature (>1200 °C) leaves graphene layer at SiC surface



• Argon-assisted graphene formation yields large (~ 100 μm^2) graphene domains

• Samples prepared using Ar atmosphere at atmospheric pressure and high temp

Atmospheric pressure Ar high temp. processing Ultrahigh vacuum mid temp. processing

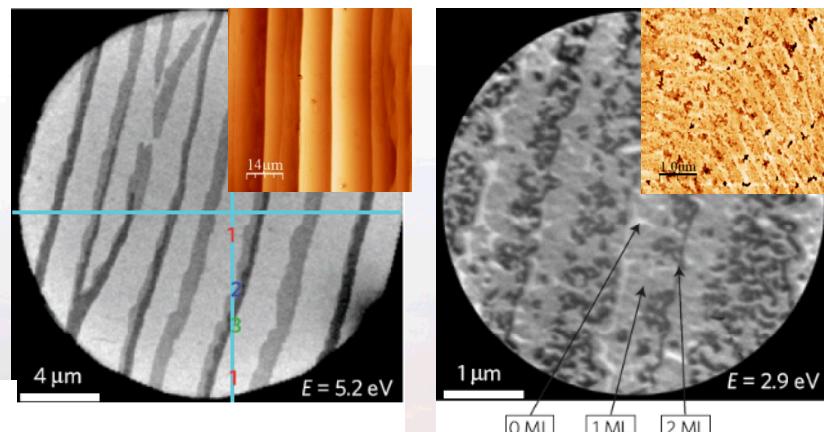


• Using this method we have exquisite control of :

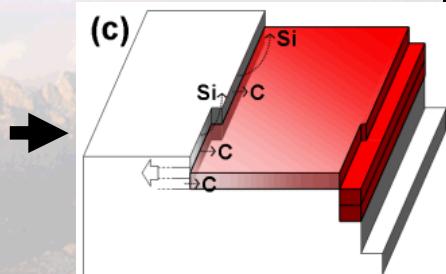
- Domain size
- Percentage coverage of mono/bilayers

• Understanding the growth mechanism of graphene on SiC

• Growth morphology strongly depends on the step structure



Step-flow growth
• Key for high large-area growth
• Real-time growth observations using LEEM



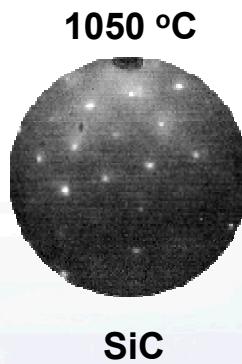
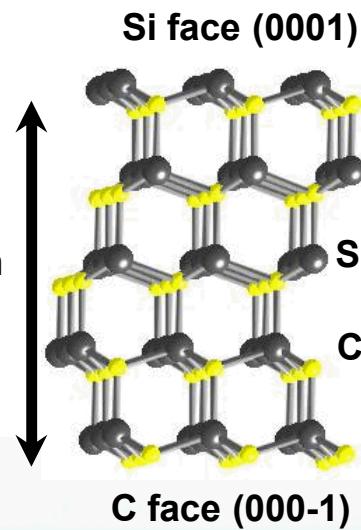
K. V. Emtsev et al., Nature Mater. 8, 203 (2009).
C. Virojanadara et al., Phys. Rev. B 78, 245403 (2008)

T. Ohta, N. C. Bartelt, S. Nie, K. Thürmer, G. L. Kellogg, PRB 81, 121411(R)(2010)

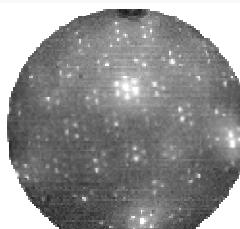
Epitaxial graphene growth on SiC



4H - SiC

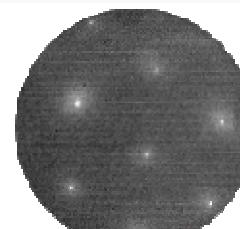


1150 °C



Buffer layer

1400 °C



Single-crystal
graphite

- 1 to few ML graphene
- Buffer layer between graphene and SiC

SiC

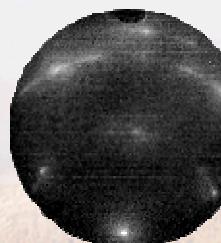
SiC

SiC

Increasing temp.



1200 °C



polycrystalline
graphite

- Many-layer graphene common
- Disordered stacking

